

MBL Series Evaluation Kit User Manual

New Generation Package Compatible Sub-1G Wireless Module E32-900MBL-01





| DISCLAIMER AND COPYRIGHT NOTICE | 2 |
|--|----|
| I PRODUCT INTRODUCTION | 3 |
| 1.1 RODUCT DESCRIPTION | |
| 1.2 SIZE, INTERFACE DESCRIPTION | |
| 1.3 SUPPORT LIST | |
| II SOFTWARE INTRODUCTION | 6 |
| 2.1 Catalog Structure | |
| 2.2 IAR Engineering | 7 |
| 2.4 Sending and Receiving Timing | |
| 2.5 Programming | |
| III QUICK DEMO | |
| 3.1 SIGNAL CABLE CONNECTION | |
| 3.2 SERIAL ASSISTANT | |
| IV FREQUENTLY ASKED QUESTIONS | 14 |
| 4.1 UNSATISFACTORY TRANSMISSION DISTANCE | |
| 4.2 MODULE IS VULNERABLE TO DAMAGE | |
| 4.3 BER IS TOO HIGH | |
| REVISION HISTORY | |
| ABOUT US | |

Disclaimer and Copyright Notice

The information in this document, including the URL address for reference, is subject to change without notice. this document is provided "as is" without warranty of any kind, including any warranties of merchantability, fitness for a particular purpose or non-infringement, and any warranties referred to elsewhere in any proposal, specification or sample. this document disclaims all liability, including liability for infringement of any patent rights arising out of the use of the information in this document. No license, express or implied, to use any intellectual property is granted herein by estoppel or otherwise.

All test data in this document are from EBYTE'S laboratory tests and actual results may vary slightly.

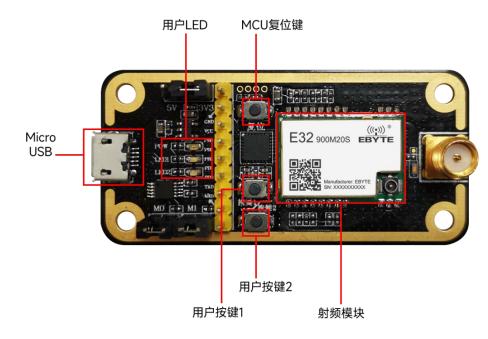
All trade names, trademarks and registered trademarks mentioned herein are the property of their respective owners and are hereby declared.

The final right of interpretation belongs to Chengdu Ebyte Electronic Technology Co.,Ltd.

Notice:

The contents of this manual are subject to change due to product version upgrade or other reasons. Chengdu Ebyte Electronic Technology Co.,Ltd. reserves the right to make changes to the contents of this manual without any notice or prompting. Chengdu Ebyte Electronic Technology Co.,Ltd. makes every effort to provide accurate information in this manual, but does not warrant that the contents of this manual are error-free, nor do all statements, information and recommendations in this manual constitute any express or implied warranty.

I Product Introduction

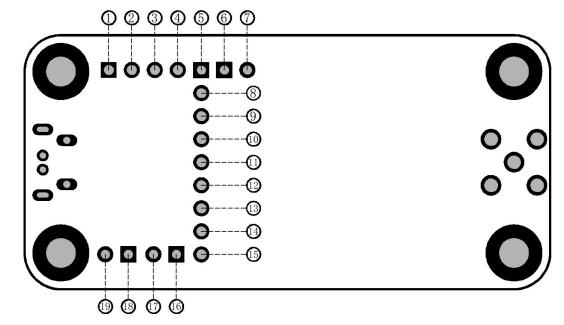


1.1 Product Description

The MBL series evaluation kits are designed to help users quickly evaluate the new generation of package-compatible wireless modules from EBST. Most of the pins on the board are already pinned out to both sides of the row of pins, so developers can easily connect a variety of peripheral devices through jumpers according to their actual needs.

The kit provides complete software application examples to help customers quickly get started with wireless data communication development. Different types of Sub-1G wireless modules can be on-board according to customer requirements. The supported modules are available in pin-compatible packages and can be quickly replaced.

1.2 Size, interface description



| Pin Serial Number | Definition | Function Description | |
|-------------------|------------|--|--|
| 1 | VCC | Module power supply pin, need to short with | |
| | | pin 2 to power the module | |
| 2 | 3.3V | 3.3V electrical lead pin | |
| 3 | 3.3V | 3.3V electrical lead pin | |
| 4 | VIO | MCU power supply pin, need to short with pin | |
| | | 3 to power MCU | |
| 5 | GND | Base plate reference ground | |
| 6 | REST | MCU external reset pins | |
| 7 | SWIM | SWIM pins of MCU | |
| 8 | VIO | MCU power supply pins | |
| 9 | PCO | Module reset pins | |
| 10 | PB7 | Module MISO Pinout | |
| 11 | PB6 | Module MOSI Pinout | |
| 12 | PB5 | Module SCLK pins | |
| 13 | PB4 | Module NSS Pinout | |
| 14 | TXD | MCU serial port TXD | |
| 15 | RXD | MCU serial port RXD | |
| 16 | M1 | Module mode switching pins (see module | |
| | | product manual for details) | |
| 17 | GND | Base plate reference ground | |
| 18 | МО | Module mode switching pins (see module | |
| | | product manual for details) | |
| 19 | GND | Base plate reference ground | |

1.3 Support List

((())) EBYTE Chengdu Ebyte Electronic Technology Co., Ltd.

MBL Evaluation Kit User Manual

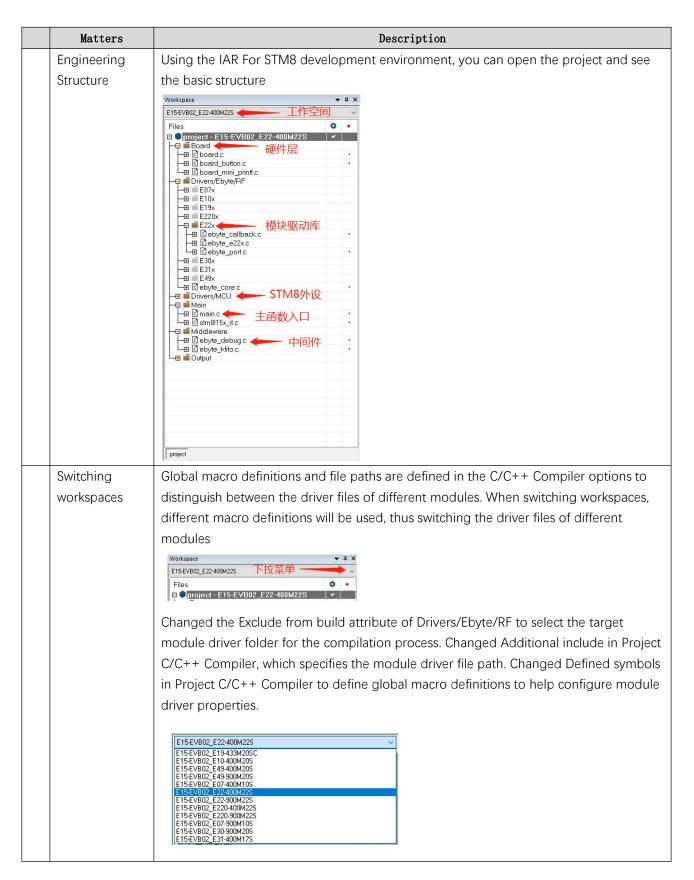
| | RF chip | Manufacturer | Module Model |
|----|---------|-------------------|---------------|
| 1 | CC1101 | Texas Instruments | E07-400M10S |
| 2 | CC1101 | Texas Instruments | E07-900M10S |
| 3 | SI4438 | Silicon Labs | E30-400M20S |
| 4 | SI4463 | Silicon Labs | E30-900M20S |
| 5 | LLCC68 | Semtech | E220-400M22S |
| 6 | LLCC68 | Semtech | E220-900M22S |
| 7 | SX1278 | Semtech | E32-400M20S |
| 8 | SX1276 | Semtech | E32-900M20S |
| 9 | SX1268 | Semtech | E22-400M22S |
| 10 | SX1262 | Semtech | E22-900M22S |
| 11 | AX5243 | ON Semiconductor | E31-400M17S |
| 12 | LLCC68 | Semtech | E220-400MM22S |
| 13 | LLCC68 | Semtech | E220-900MM22S |

${\rm I\!I}$ Software Introduction

2.1 Catalog Structure

| | Matters | Description | | |
|---|----------------|--|--|--|
| 1 | File Directory | You can download the sample project from the official website and open the directory | | |
| | | as shown below | | |
| | | | | |
| | | 0_Project | | |
| | | 1_Middleware | | |
| | | 2_Ebyte_Board_Support | | |
| | | 3_Ebyte_WirelessModule_Drivers | | |
| | | 4_STM8_L15x_StdPeriph_Drivers | | |
| | | | | |
| 2 | Catalog | You can use the IAR For STM8 development environment to find the entry file to open | | |
| | Description | the project | | |
| | | | | |
| | | ├─ E15-EVB02 Demo //主文件夹 | | |
| | | L L O Breitest | | |
| | | | | |
| | | | | |
| | | │ | | |
| | | Ⅰ I I H Kfifo //通用数据队列 | | |
| | | I I └─ Produce //PC测试 | | |
| | | | | |
| | | 2_Ebyte_Board_Support | | |
| | | └─ E15-EVB02 //板载资源初始化 | | |
| | | | | |
| | | ├- 3_Ebyte_WirelessModule_Drivers ├- E07xMx //E07模块驱动 | | |
| | | I I I I I E10xMx //E10模块驱动 | | |
| | | H E19xMx //E19模块驱动 | | |
| | | ├─ E22xMx //E22模块驱动 | | |
| | | ├─ E30xMx //E30模块驱动 | | |
| | | ├─ E31xMx //E31模块驱动 | | |
| | | H E49xMx //E49模块驱动 | | |
| | | L E220xMx //E220模块驱动 | | |
| | | | | |
| | | L 4_STM8_L15x_StdPeriph_Drivers | | |
| i | | | | |

2.2 IAR Engineering

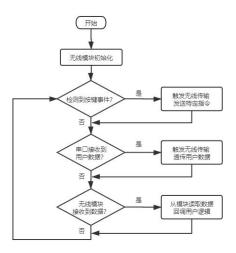


2.3 Main Functions

main.c is the main function entry. The flow of the demo function is simplified as follows.

| | Matters | Description | |
|---|-------------------------|--|--|
| 1 | Key Function | If a key is pressed, the command data is sent wirelessly. In essence, it is sending a | |
| | | specific string "ping" and expecting to receive a response "pong". | |
| 2 | Serial data to wireless | After the serial port receives the data, it automatically starts to transmit the data | |
| | transmission | wirelessly, which of course contains some special command responses, mainly for | |
| | | special tests, which the user can ignore. After the transmission is completed, it will | |
| | | automatically call back the user function and thus handle the transmission logic | |
| | | by itself. | |
| 3 | Receive data | Generally it reads the module internal state marker to determine if there is data, | |
| | wirelessly | and the underlying driver will copy the data and pass it to the user callback | |
| | | function, thus handling the receiving logic itself | |

The software process is simplified as shown in the following diagram.



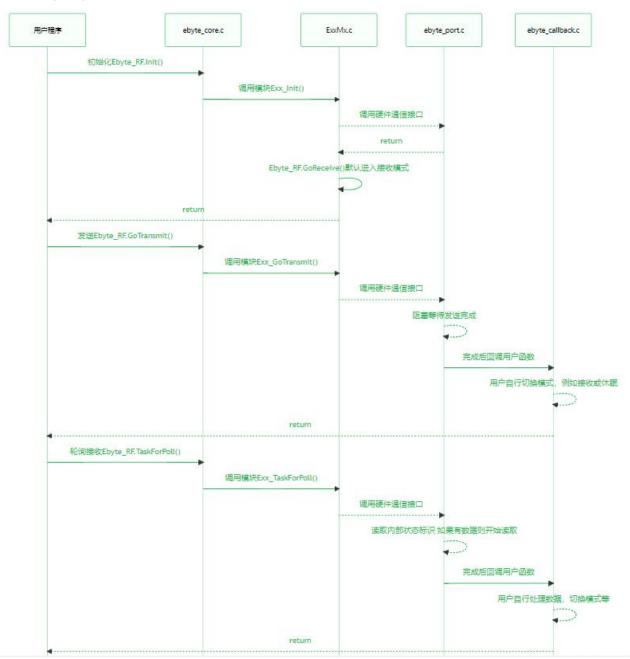
2.4 Sending and Receiving Timing

Wireless modules exist in multiple operating states and can only perform specific functions in the corresponding states. In terms of the simplest sending and receiving data, only the transmitting mode and receiving mode are considered.

| | Matters | Description | |
|---|----------------|--|--|
| 1 | Receiving Mode | It automatically enters receive mode after the default initialization is completed. In | |
| | | essence, this means that the receive function is called during initialization and | |
| | | thus enters receive mode. If you want to consider entering other modes after | |
| | | initialization, such as sleep, you can directly replace the function Go_xxxxx() with | |
| | | the same type. | |
| 2 | Sending Mode | When the transmit function is called, the underlying driver actually switches the | |
| | | module into standby mode first, where the configuration of modulation | |
| | | parameters, such as frequency, power, frequency bias, etc., is usually done. After | |
| | | the parameters are configured correctly, it gradually enters some intermediate | |

| | modes, turning on the internal FIFO, PA, external XTAL, etc., and the current |
|--|---|
| | consumption gradually climbs. Finally switch into transmit mode to trigger |
| | wireless data transmission. After completion, the module enters standby mode, |
| | this state can not continue to send and receive, and the user needs to handle the |
| | next mode in the callback function by himself. When the function is complicated |
| | and continuous receiving or continuous transmitting is needed, please further |
| | switch to other modes according to the chip characteristics. |

The timing diagram is shown below.



2.5 Programming

| | Documents | Key Notes |
|---|------------------|---|
| 1 | ebyte_core.h | A module structure is defined that abstracts the basic functionality to which the functions of the underlying module will be bound. When used for simple sending and receiving applications, it is not necessary to understand the underlying details of each module's work, and the abstracted functions can be called directly to start sending and receiving data. If you need to customize some functions, you can also consider integrating them into this structure. If you know enough about the functions of the underlying modules, you can also remove the ebyte_core.c/h file, and there is no strong coupling between the <pre> typedef struct { uintBe_t (*forTransmit)(uintBe_t*buffer, uintBe_t size); //DIRESEMENT THE/FMMENTE uintBe_t (*GoReceive)(void); //ZIMENTEMENTE (#UMENTEMENTE (#UMENTEMENTE) uintBe_t (*GoReceive)(void); //ZIMENTEMENTE (#UMENTEMENTE) uintBe_t (*GoReceive)(void); //ZIMENTEMENTE (#UMENTEMENTE) uintBe_t (*GotTransmit)(uintBe_t*appletemente) uintBe_t (*GotTransmit)(uintBe_t*buffer, uintBe_t size); //ZIMENTEMENTE(#UMENTE) uintBe_t (*GotTransmit)(uintBe_t*buffer, uintBe_t size); //ZIMENTEMENTE(#UMENTE) uintBe_t (*GotTransmit)(uintBe_t*Appletemente) uintBe_t (*GotTransmit)(uintBe_t*buffer, uintBe_t size); //ZIMENTEMENTE(#UMENTE) uintBe_t (*GotTransmit)(uintBe_t*Appletemente) uintBe_t (*GotTransmit)(uintBe_t*Appletement</pre> |
| 2 | ebyte_exx.c | It is a specific module driver file, which is generally encapsulated and does not |
| 3 | ebyte_port.c | require user changes, only how to input and output data from this "box". Specifically designed to bind SPI and GPIO on different hardware platforms, |
| | | abstracted as "box" inputs. Users need to populate their hardware platforms with communication interfaces in fixed locations according to the comments. In general, it is to provide the SPI send/receive function and the pin level control. Some modules are slightly special, such as the E49 using half-duplex SPI, if you are too lazy to write the communication driver, then directly bind the IO to a fixed location, and leave the rest to the module driver to simulate their own IO to achieve communication. As shown in the figure below, in the comments required to provide the SPI interface location to fill in the specific send and receive functions, from send to pass the SPI send data, by the result to return the SPI receive |
| | ebyte_callback.c | It is specifically designed to bind the user's own sending and receiving logic, abstracted as the output of a "box". Essentially, the module driver calls the user's callback function directly after determining whether sending or receiving is complete |
| | | abstracted as the output of a "box". Essentially, the module driver calls the user's callback function directly after determining whether sending or receiving is complete |

| | As shown below, the user's logic is populated in the To-do prompt position. state is |
|---------------------|---|
| | passed from the module driver and actually handled by the Exx_GoTransmit() |
| | function, which can be modified to support more cases when the functionality is |
| | complex. |
| | <pre>/*! * @brief 发送完成回调接口 由客户实现自己的发送完成逻辑 * @param state 上层回调提供的状态码 客户请根据示例注释线到对应区域 */ void Ebyte_Port_TransmitCallback(uint16e_t state) { /* 发送: 正常完成 */ iff(state &= 0x0001) { //To-do 实现自己的逻辑 UserTransmitDoneCallback(); } /* 发送: 其他情况 */ else { //To-do 实现自己的逻辑 } }</pre> |
| ebyte_exx.h | Some general modulation parameters are defined, which usually do not need to be modified and can be adjusted in them by yourself. Note, please understand the comments when modifying, there is a range check for the parameters in the module driver, wrong modulation parameters will lead to initialization failure. The following is an example of FSK modulation |
| | #define E07_DATA_RATE 1200 //空速 1.2 KBps #define E07_FREQUENCY_DEVIATION 14300 //顔順 14.3 K #define E07_BANDWIDTH 58000 //接收宽宽 58 K #define E07_OUTPUT_POWER 10 //bæ [10 7 5 0 -10 -15 -20 -30] #define E07_PREAMBLE_SIZE 4 //前母码长度 [0:2 1:3 2:4 3:6 4:8 5:12 6:16 7:24] #define E07_SYNC_WORD 0x2DD4 //同步字 #define E07_IS_CRC 1 //CRC开关 [0:关闭 1:开启] parameters. |
| board.c | STM8 peripheral initialization, involving SPI, TIMER, GPIO, etc., strongly coupled to the hardware used. |
| board_button.c | The keystroke event queue, in terms of data structure, is a FIFO, and the timer detects the keystroke and stores the corresponding event in the queue waiting for the main loop to respond. |
| board_mini_printf.c | A simplified printf, with reduced functionality but a small footprint. The DEBUG macro in the project relies heavily on the mprintf provided by this file. |
| ebyte_kfifo.c | For serial data reception, optimized for general-purpose FIFO queues, suitable for caching. |
| ebyte_debug.c | Used to connect to a PC for some tests, generally not required. |
| stm8l15x_it.c | All interrupt functions are entered here, and the interrupt service functions for serial, timer, key IO, etc. are concentrated here. |

III Quick Demo

3.1 Signal cable connection

| | Matters | Description |
|---|------------------------------|--|
| 1 | Power Jumper Cap | |
| 2 | Mode selection jumper cap | WCCWUUUUUUUUUUUUUUUUUUUUUUUUUUUUUUUUUU |
| 3 | Assistance | USB cable, antenna, PC, etc. |

3.2 Serial Assistant

| | Matters | Description |
|---|--|---|
| 1 | Device Manager View Serial Port Number | 会響管理器 文件(E) 操作(a) 查看(v) 報助(c) ● ● ● |
| 2 | Serial Software | XCOM V2.0 × Protect module initialization supcess. Hence: E31-40001 75 This is an excepted of sireless transmission = Protect mutual or button? With B = 000 With B = 0000 With B = 000 With B = 0000 With B = 000 With B = 0000 With B = 000 With B = 0000 With B = 00000 With B = 00000 With B = 00000 With B = 00000 |
| 3 | Key communication example | The #RECV identifier, used only for hints, indicates data received by the wireless module. The #SEND identifier, used only for hints, indicates data sent by the wireless module |
| 4 | Serial Data Transit | Serial data pass-through Direct transmission of the required content via |

| - inis is an example of wireless framewission | COM53: USB-SERIAL ~ |
|--|---------------------|
| #SEND: ping | 波特率 9600 ~ |
| #RECV: BOARS WAITING FOR YOU #RECV: Hollo World | 停止位 1 ~ |
| | 数据位 8 ~ |
| | 奇偶校验 无 ~ |
| | 串口操作 💓 关闭串口 |
| | 保存窗口 清除接收 |
| хсом | □ 16进制显示□ 白底黑字 |

$\operatorname{I\!V}$ Frequently Asked Questions

4.1 Unsatisfactory transmission distance

- A corresponding attenuation of communication distance when linear communication barriers exist.
- Temperature, humidity, and co-channel interference, which can lead to higher communication packet loss rates.
- The ground absorbs and reflects radio waves, and the test effect is poor near the ground.
- seawater has a very strong ability to absorb radio waves, so the seaside test effect is poor.
- metal objects near the antenna, or placed in a metal shell, signal attenuation will be very serious.
- Wrong setting of power register, too high setting of air rate (the higher the air rate, the closer the distance).
- the low voltage of the power supply at room temperature is lower than the recommended value, the lower the voltage the less power is generated
- The use of antenna and module match the degree of poor or antenna itself quality problems.

4.2 Module is vulnerable to damage

- Please check the power supply to ensure that it is between the recommended supply voltages, as exceeding the maximum will cause permanent damage to the module.
- Please check the stability of the power supply, the voltage should not fluctuate significantly and frequently.
- Please ensure that the installation and use process anti-static operation, high-frequency devices electrostatic sensitivity.
- Please ensure that the installation and use process humidity should not be too high, some components are humidity-sensitive devices.
- If there is no special demand is not recommended to use at too high or too low temperature.

4.3 BER is too high

- Nearby interference with the same frequency signal, away from the source of interference or modify the frequency, channel to avoid interference.
- unsatisfactory power supply may also cause garbled codes, be sure to ensure the reliability of the power supply.
- Poor quality or too long extension cable or feeder line may also cause high BER.

Revision History

| Versions | Revision Date | Revision Notes | Maintainer |
|----------|---------------|---|------------|
| 1.0 | 2021-09-22 | Initial Version | JH |
| 1.1 | 2022-12-29 | Modify the module diagram and how to use it | HWJ |

About us



